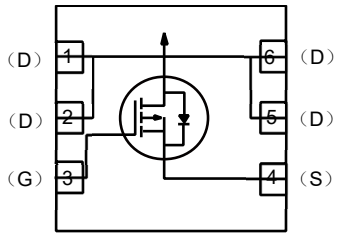
Description

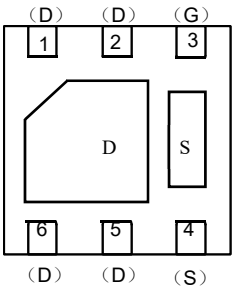
The enhancement mode MOS is extremely high density cell and low on-resistance.

MOSFET Product Summary		
V_{DS}(V)	$R_{DS(on)}$(mΩ)	I_D(A)
-30	21 @ V_{GS}=-4.5V	-9

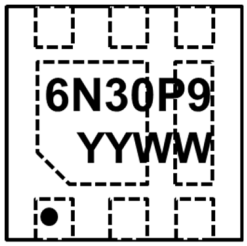
Internal structure



Bottom View



Marking



PIN1

Absolute maximum rating@25℃

Rating		Symbol	Value	Units
Drain-Source Voltage		V_{DS}	-30	V
Gate-Source Voltage		V_{GS}	±12	V
Drain Current	Continuous T_A=25℃	I_D	-9	A
	Pulsed T_A=70℃	I_D	-36	A
Total Power Dissipation	T_A=25℃	P_D	2.4	W
	T_A=125℃	P_D	0.9	W
Operating and Storage Junction Temperature Range		T_J,T_{STG}	-55 to +150	℃

Thermal Characteristics

Parameter		Symbol	Max.	Units
Thermal Resistance, Junction to Ambient	(Note 1)	$R_{\theta JA}$	52	℃/W
Thermal Resistance, Junction to Ambient	(Note 2)	$R_{\theta JA}$	145	
Thermal Resistance, Junction to Case		$R_{\theta JC}$	6.9	

Electrical characteristics per line@25℃(unless otherwise specified)

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Units
Drain-Source Breakdown Voltage	BV_{DSS}	I_D =-250μA,V_{GS}=0V	-30	-	-	V
Zero Gate Voltage Drain Current	I_{DSS}	V_{DS} =-30V,V_{GS}=0V	-	-	-1.0	μA
Gate-to-Source Forward Leakage	I_{GSS}	V_{GS}=±12V	-	-	±100	nA
Gate Threshold Voltage	$V_{GS(th)}$	V_{DS} =V_{GS}, I_D =-250μA	-0.6	-1.0	-1.5	V
Static Drain-Source On-Resistance	$R_{DS(ON)}$	V_{GS}=-4.5V, I_D =-5.5A	-	21	28	mΩ
		V_{GS}=-2.5V, I_D =-5A,	-	28	40	mΩ
Maximum Body-Diode Continuous Current	I_s	-	-	-	-9.0	A
Forward Trans conductance	g_{FS}	V_{DS}=-5V, I_D =-9A	21	-	-	S
Total Gate Charge	Qg	I_D =-9A, V_{DD} =-6V, V_{GS} =-4.5V	-	13.8	-	nC
Gate-to-Source Charge	Qgs		-	2.5		
Gate-to-Drain(Miller) Charge	Qgd		-	3.3		
Input Capacitance	C_{ISS}	V_{GS}=0V, V_{DS} =-15V, f=1MHz	-	780		pF
Output Capacitance	C_{DSS}		-	150		pF
Reverse Transfer Capacitance	C_{RSS}		-	98		pF
Turn-On Delay Time	$t_{d(on)}$	V_{DD}=-6.0V, I_D =-9A, V_{GS}=-4.5V , R_{GEN}=6Ω,	-	11	-	ns
Rise Time	t_r		-	8	-	
Turn-Off Delay Time	$t_{d(off)}$		-	28.5	-	
Fall Time	t_f		-	10.5	-	
Source to Drain Diode Forward Voltage	V_{SD}	V_{GS}=0V,I_S=-2A		-0.6	-1.2	V

Note1: Surface mounted on FR4 Board using 1 square inch pad size, 1oz copper

Note2: Surface mounted on FR4 board using minimum pad size, 1oz copper

Note3: Pulse Test: Pulse Width ≤ 300μs, Duty Cycle ≤ 2%.

Note4: Guaranteed by design, not subject to production

Typical Characteristics

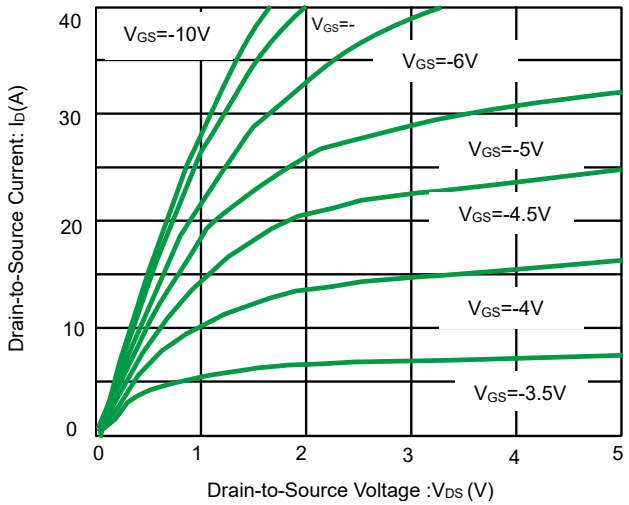


Fig 1. Output Characteristics

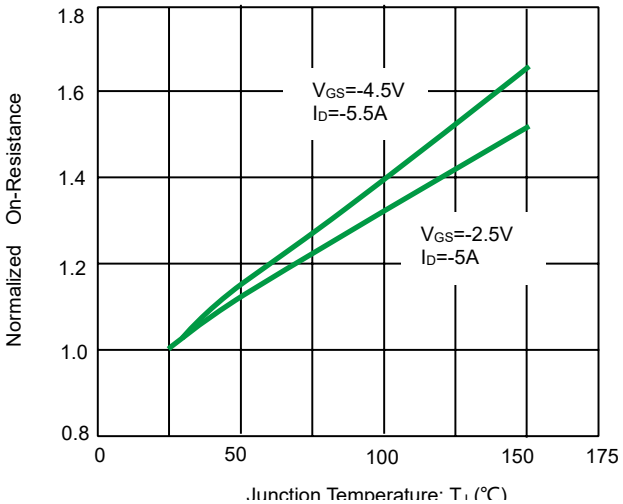


Fig 2. Normalized On-Resistance vs. Junction Temperature

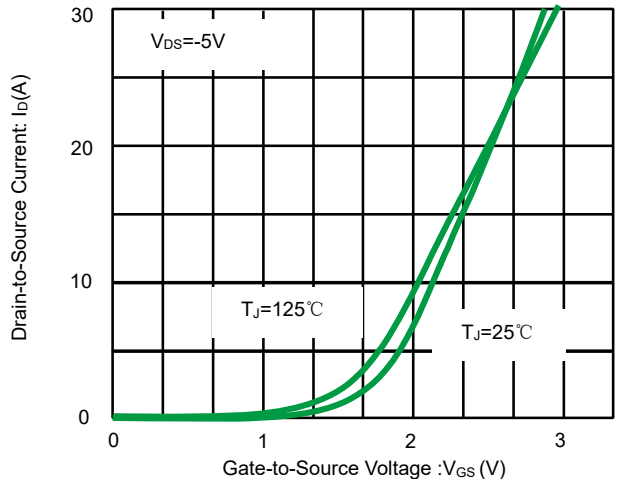


Fig 3. Transfer Characteristics

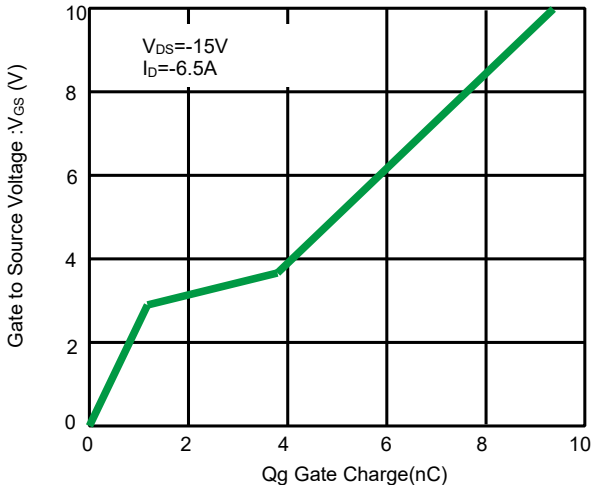


Fig 4. Gate Charge

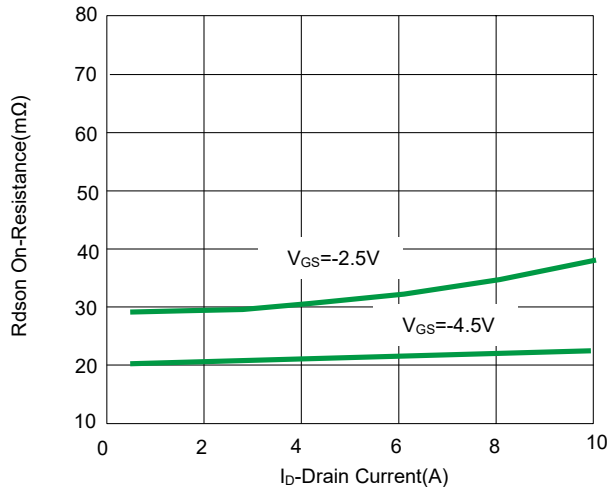


Fig 5. Rdson-Drain Current

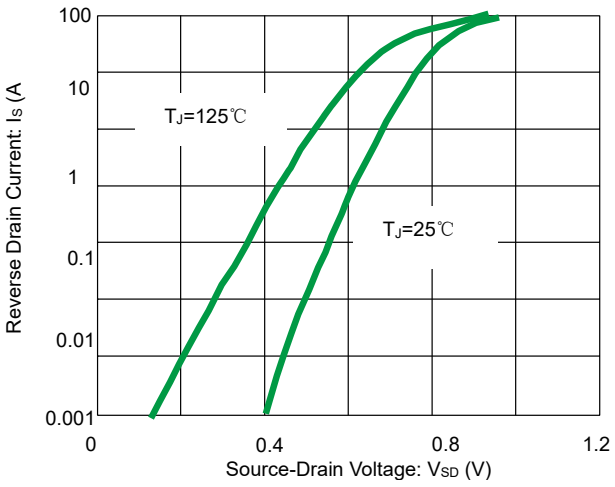


Fig 6. Source to Drain Diode Forward Voltage vs. Source Current

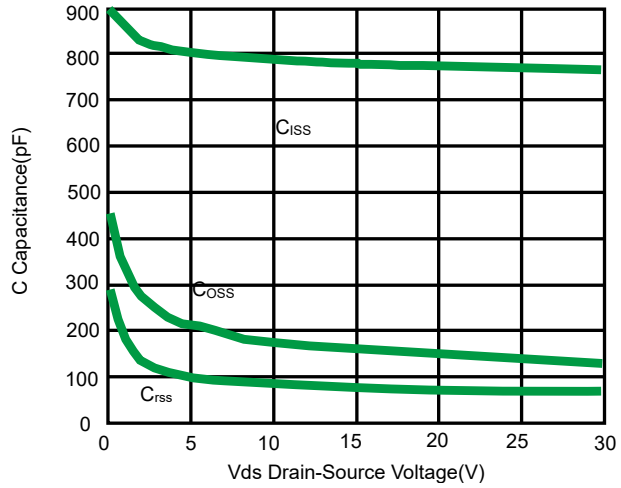


Fig 7. Capacitance vs Vds

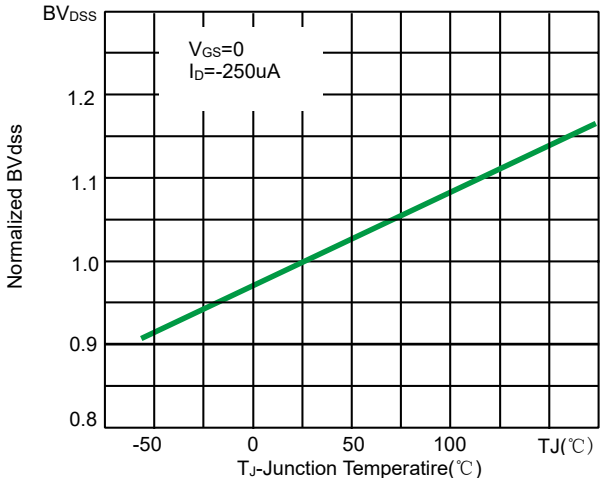


Fig 8. BV_{DSS} vs Junction Temperature

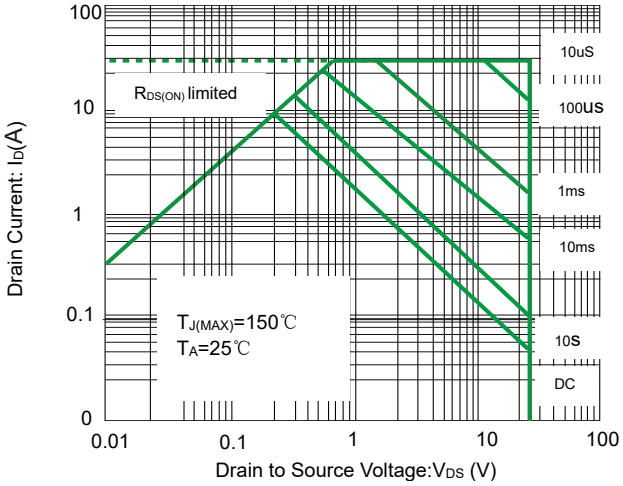


Fig 9. Forward Bias Safe Operating Area

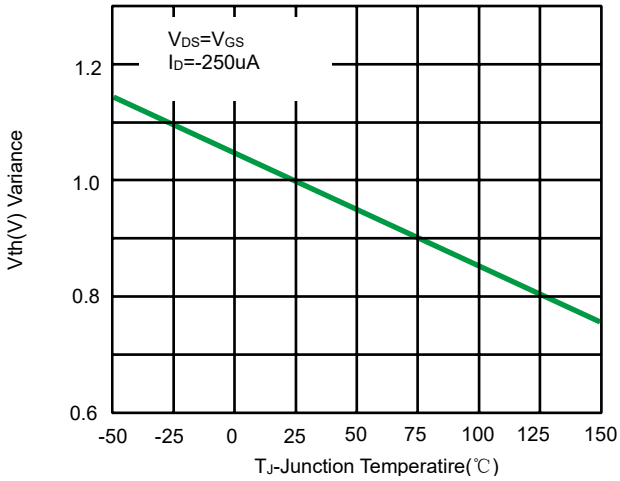


Fig 10. $V_{GS(th)}$ vs Junction Temperature

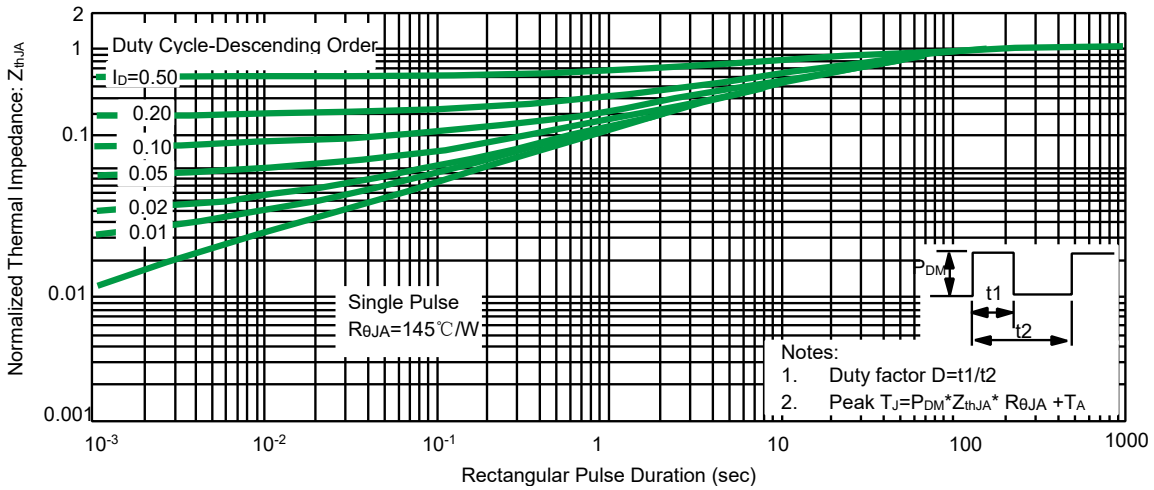
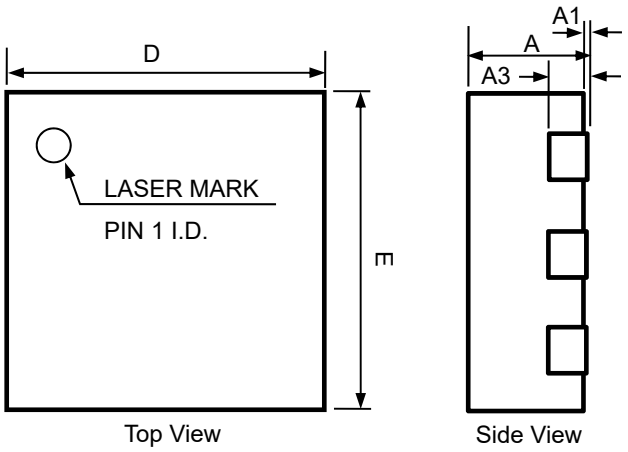
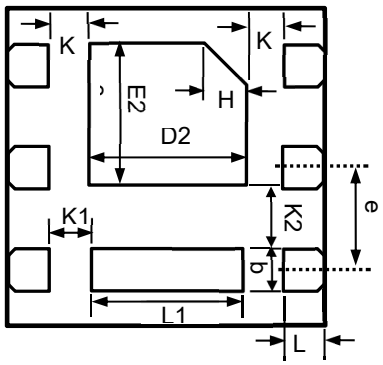


Fig 11. Transient Thermal Response Curve, Junction-to-Ambient

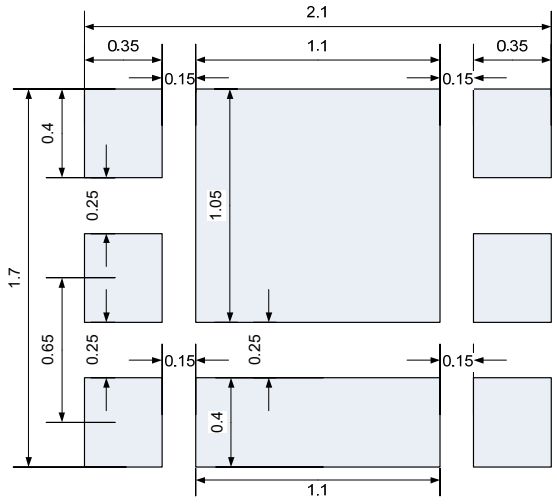
Product dimension （DFN2*2-6L）



Dim	Millimeters		
	MIN	NOM	MAX
A	0.70	0.75	0.80
A1	0.00	0.02	0.05
A3		0.20 Ref.	
b	0.25	0.30	0.35
D	1.90	2.00	2.10
E	1.90	2.00	2.10
D2	0.90	1.00	1.10
E2	0.80	0.90	1.00
e	0.55	0.65	0.75
H		0.25 Ref.	
K	0.15	--	--
K1	0.20	--	--
K2	0.25	--	--
L	0.20	0.25	0.30
L1	0.65	0.75	0.85



Bottom View



Suggested PCB Layout

Ordering information

Device	Package	Reel	Shipping
PPM6N30V9	DFN2*2-6L (Pb-Free)	7"	3000 / Tape & Reel

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